

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
BAU-RU LU	11/02/2016
JENG-JEN LI	11/02/2016
KUN-HONG SHIH	11/02/2016
KAIPENG CHIANG	11/02/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	CYNTEC CO., LTD.
<b>Street Address:</b>	NO. 2, RESEARCH & DEVELOPMENT 2ND RD. SCIENCE PARK
<b>City:</b>	HSINCHU
<b>State/Country:</b>	TAIWAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15334308
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	JANICESHIH@LITRON-INTL.COM
<b>Correspondent Name:</b>	LITRON INTERNATIONAL PATENT & TRADEMAKRK OFFICE
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<b>ATTORNEY DOCKET NUMBER:</b>	6101.021US
<b>NAME OF SUBMITTER:</b>	MIN-LEE TENG
<b>SIGNATURE:</b>	/MIN-LEE TENG/
<b>DATE SIGNED:</b>	12/12/2016
<b>Total Attachments: 2</b>	
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**ASSIGNMENT  
(PATENT APPLICATION)**

WHEREAS, we, (“ASSIGNORS”):

<u>Inventor</u>	<u>Citizenship</u>	<u>Address</u>
LU, BAU-RU	Taiwan, R. O. C.	No.17, Ln. 58, Taihua St., Changhua City, Changhua County 500, Taiwan (R.O.C.)
LI, JENG-JEN	Taiwan, R. O. C.	2F., No.6, Aly. 1, Ln. 437, Sec. 2, Bade Rd., Songshan Dist., Taipei City 105, Taiwan (R.O.C.)
SHIH, KUN-HONG	Taiwan, R. O. C.	No.19, Ln. 659, Xida Rd., East Dist., Hsinchu City 300, Taiwan (R.O.C.)
CHIANG, KAIPENG	Taiwan, R. O. C.	No.150, Shulin 4th St., Taoyuan City, Taoyuan County 330, Taiwan (R.O.C.)

having invented a certain new and useful invention entitled:

**PACKAGE STRUCTURE AND THE METHOD TO FABRICATE  
THEREOF**

for which a United States patent application is to be filed or has been filed on OCT. 26, 2016 under U.S. Patent Application No. 15/334,308 ; and

WHEREAS, (“ASSIGNEE”):

**CYNTEC CO., LTD.  
NO. 2, RESEARCH & DEVELOPMENT 2ND RD.  
SCIENCE PARK, HSINCHU  
TAIWAN, R.O.C.**

is desirous of acquiring the entire right, title and interest in and to the invention throughout the United States and the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all countries throughout the world;

FOR GOOD and VALUABLE CONSIDERATION, the full receipt and sufficiency of which are hereby acknowledged, ASSIGNORS, intending to be legally bound, do hereby:

AUTHORIZE said ASSIGNEE, or its representatives to insert above the filing date and application number of the application when these are known;

SELL, ASSIGN, TRANSFER and CONVEY to ASSIGNEE the whole and entire right, title and interest for the United States and its possessions and territories and all foreign countries in and to the invention which is disclosed in the above-identified patent application, and, in and to any and all patent applications related thereto including, but not limited to, all provisionals, non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues and all other applications for patent which have been or shall be filed in the United States and all foreign countries on the invention; all original, reissued and reexamined patents and extensions thereof which have been or shall be issued in the United States and all foreign

countries on the invention to the full end of the term or terms for which the patent(s) may be granted, as fully and entirely as the same would have been held by the undersigned

ASSIGNOR(S) had this Assignment not been made; and specifically including all rights of priority created by the above patent application under any treaty, convention or law relating thereto;

AUTHORIZE and REQUEST the issuing authority to issue any and all United States and foreign patents granted on the invention to ASSIGNEE;

WARRANT and REPRESENT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by ASSIGNORS, and that the full right to convey the same as herein expressed is possessed by ASSIGNORS;

AGREE and UNDERTAKE, when requested and at the expense of ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, ASSIGNORS will execute all non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues, and all other patent applications on the invention; execute all lawful oaths, declarations, assignments, powers of attorney and other papers; communicate to ASSIGNEE all facts known to ASSIGNORS relating to the invention and the history thereof; and generally do everything possible which ASSIGNEE shall consider desirable for vesting title to the invention in ASSIGNEE, and for securing, maintaining and enforcing proper patent protection for the invention; all without further compensation to ASSIGNORS;

AGREES to hold in trust, keep confidential, not make use of, and not disclose or reveal to any third party said invention, without ASSIGNEE'S prior written consent.

TO BE BINDING on the heirs, assigns, representatives and successors of ASSIGNORS and extending to the successors, assigns, and nominees of ASSIGNEE.

11/02/2016	/ LU, BAU-RU /
_____ Date	_____ LU, BAU-RU
11/02/2016	/ LI, JENG-JEN /
_____ Date	_____ LI, JENG-JEN
11/02/2016	/ SHIH, KUN-HONG /
_____ Date	_____ SHIH, KUN-HONG
11/02/2016	/ CHIANG, KAIPENG /
_____ Date	_____ CHIANG, KAIPENG